Preliminary Amendment

Application Number: 10/572,377

Attorney Docket No. 062284

AMENDMENTS TO THE CLAIMS

The following listing of claims replaces all prior versions of claims in the application.

1. (Currently amended): An optical fiber wiring method comprising the steps of feeding

an optical fiber to pass through an adhesive ejecting nozzle having an inner diameter larger than an

outer diameter of the optical fiber, to thereby obtain the optical fiber coated with the adhesive on

a fiber surface, and forming optical wiring on a substrate by using the adhesive-coated

simultaneously ejecting the optical fiber and the adhesive.

2. (Currently amended): The optical fiber wiring method according to Claim 1, wherein the

optical wiring is formed on the substrate by moving the substrate and the nozzle relative to each

other an amount of the adhesive is held constant by controlling a speed at which the optical fiber is

introduced and an air pressure for pushing out the adhesive.

3. (Currently amended): The optical fiber wiring method according to Claim [[2]] 1 or 2,

wherein the optical wiring is formed on the substrate by relative movement of the substrate and the

nozzle is performed by moving the nozzle with the substrate held fixed and the nozzle moved.

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4. (Currently amended): The optical fiber wiring method according to Claim [[2]] 1 or 2,

wherein the optical wiring is formed on the substrate by relative movement of the substrate and the

nozzle is performed by moving the substrate with the nozzle held fixed and the substrate moved.

5. (Currently amended): The optical fiber wiring method according to any one of Claims

1-to-4 Claim 1 or 2, wherein the optical fiber is a polymer optical fiber.

6. (Currently amended): The optical fiber wiring method according to any one of Claims

1-to 5 Claim 1 or 2, wherein the adhesive is of the type being hardened with irradiation of an

ultraviolet ray, and the optical wiring is formed on the substrate by irradiating an ultraviolet ray

after the optical fiber coated with the adhesive on the fiber surface has been wired on the substrate.

7. (Original): An optical fiber wiring apparatus comprising a liquid material ejecting unit

provided with a liquid material ejecting nozzle having an inner diameter larger than an outer

diameter of an optical fiber and allowing the optical fiber and the adhesive to be simultaneously fed

through the nozzle, and a stage for supporting a substrate on which the optical fiber is to be wired,

wherein the liquid material ejecting unit and the stage are movable relative to each other.

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8. (Currently amended): The optical fiber wiring apparatus according to Claim 7, wherein

the stage for supporting the substrate is fixed, and the nozzle is movable to form optical wiring on

the substrate with the relative movement.

9. (Currently amended): The optical fiber wiring apparatus according to Claim 7, wherein

the nozzle is fixed, and the stage for supporting the substrate is movable to form optical wiring on

the substrate with the relative movement.

10. (Currently amended): The optical fiber wiring apparatus according to any one of

Claims [[6 to 9]] 7 to 9, wherein the adhesive is of the type being hardened with irradiation of an

ultraviolet ray, and the apparatus further comprises an ultraviolet ray irradiation unit for irradiating

an ultraviolet ray to harden the adhesive after the optical fiber coated with the adhesive on the fiber

surface has been wired on the substrate.

11. (New): The optical fiber wiring apparatus according to any one of Claims 7 to 9,

wherein an amount of the adhesive is held constant by controlling a speed at which the optical fiber

is introduced and an air pressure for pushing out the adhesive.

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